





#### Features:

- DC 2.5 GHz
- 40 Watts
- AIN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

# Chip Termination 40 Watts, 50Ω

## **General Specifications**

Resistive Element Thick film

SubstrateAluminum nitride ceramicTerminalsTin/Lead, 90/10 over nickel

#### **Electrical Specifications**

Resistance Range: 50 ohms,  $\pm$  2% Power: 50 ohms,  $\pm$  2% DC - 2.5 GHz 40 Watts

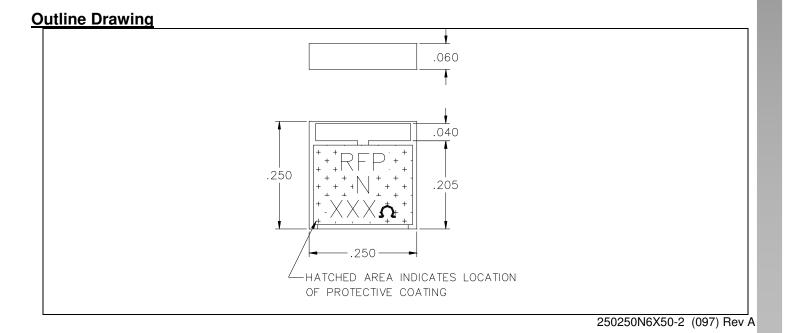
ower. 40 walls

**VSWR** 1.3:1 DC – 2.5 GHz

**Note:** Tolerance is ±0.010", unless otherwise specified. Designed to meet of exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 150°C (see chart for derating temperatures).

All dimensions in inches.

Specifications subject to change with out notice.







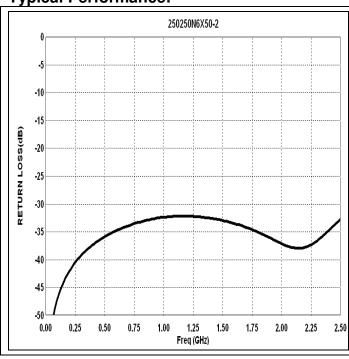
Available on Tape and Reel For Pick and Place Manufacturing.

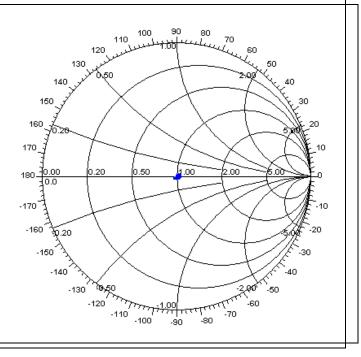
USA/Canada: (315) 432-8909 Toll Free: (800) 544-2414 Europe: +44 2392-232392



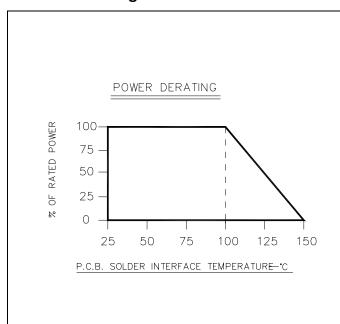


**Typical Performance:** 

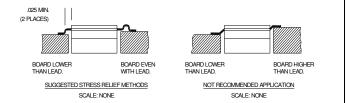




## Power De-rating:



# **Mounting Footprint and Procedure:**



#### SUGGESTED MOUNTING PROCEDURES:

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- 2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
- 3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
- POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
- 5. SOLDER LEADS IN PLACE USING APPROPROATE SOLDER WITH A CONTROLLED TEMPERATURE IRON.

\*\* FOR MORE DETAILS CONTACT FACTORY \*\*

250250N6X50-2 (097) Rev A

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